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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/212,915	12/16/1998	HIDEMI TAKASU	A28838-I-A	7678
7590 12/03/2003		EXAMINER		
BAKER & BOTTS			ESTRADA, MICHELLE	
30 ROCKEFELLER PLAZA NEW YORK, NY 10112			ART UNIT	PAPER NUMBER
·			2823	

DATE MAILED: 12/03/2003

Please find below and/or attached an Office communication concerning this application or proceeding.

			M
	Application No.	Applicant(s)	
	09/212,915	TAKASU, HIDEMI	
Office Action Summary	Examiner	Art Unit	
	Michelle Estrada	2823	
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet with the	correspondence addres	ss
A SHORTENED STATUTORY PERIOD FOR REPLY THE MAILING DATE OF THIS COMMUNICATION.  - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thirty (30) days, a reply If NO period for reply is specified above, the maximum statutory period volume are period for reply within the set or extended period for reply will, by statute, any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).  Status	36(a). In no event, however, may a reply be ti y within the statutory minimum of thirty (30) da vill apply and will expire SIX (6) MONTHS fron , cause the application to become ABANDON!	mely filed ys will be considered timely. the mailing date of this commuED (35 U.S.C. § 133).	nication.
1) Responsive to communication(s) filed on 23 O	ctober 2003.		
2a) This action is <b>FINAL</b> . 2b) ☐ This	action is non-final.		
3) Since this application is in condition for allowar closed in accordance with the practice under E			erits is
Disposition of Claims			
4)⊠ Claim(s) <u>1 and 3-9</u> is/are pending in the application	ation.		
4a) Of the above claim(s) is/are withdraw			
5) Claim(s) is/are allowed.			
6)⊠ Claim(s) <u>1 and 3-9</u> is/are rejected.			
7) Claim(s) is/are objected to.			
8) Claim(s) are subject to restriction and/o	r election requirement.		
Application Papers			
9) The specification is objected to by the Examine	ır.		
10) The drawing(s) filed on is/are: a) acce		Examiner.	
Applicant may not request that any objection to the	drawing(s) be held in abeyance. Se	e 37 CFR 1.85(a).	
Replacement drawing sheet(s) including the correct	ion is required if the drawing(s) is ol	ejected to. See 37 CFR 1	.121(d).
11)☐ The oath or declaration is objected to by the Ex	caminer. Note the attached Office	e Action or form PTO-1	52.
Priority under 35 U.S.C. §§ 119 and 120			
<ul> <li>12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of:</li> <li>1. Certified copies of the priority document</li> <li>2. Certified copies of the priority document</li> <li>3. Copies of the certified copies of the priority</li> </ul>	s have been received. s have been received in Applica	ion No	ne
application from the International Bureau * See the attached detailed Office action for a list 13) Acknowledgment is made of a claim for domesti	u (PCT Rule 17.2(a)). of the certified copies not receiv c priority under 35 U.S.C. § 119	ed. e) (to a provisional ap	olication)
since a specific reference was included in the first 37 CFR 1.78.  a)  The translation of the foreign language pro			a Sheet.
14) Acknowledgment is made of a claim for domesti reference was included in the first sentence of the	c priority under 35 U.S.C. §§ 12	and/or 121 since a sp	
Attachment(s)			
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449) Paper No(s)	5) Notice of Informal	y (PTO-413) Paper No(s) Patent Application (PTO-15	

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## **DETAILED ACTION**

A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on 10/23/03 has been entered.

## Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 1 and 3-9 are rejected under 35 U.S.C. 103(a) as being unpatentable over Japanese Patent 63-261833 (Japan '833) in combination with Wolf (Vol. 1), and further in view of Bayraktaroglu (US 5,166,083).

Japan '833 discloses formation of a buried layer by implantation of either p-type or a n-type conductive impurity through an opening in a patterned layer followed by annealing and formation of an epitaxial layer on the substrate surface. The use of a photoresist layer on a patterned insulating layer as the implantation mask is disclosed to be entirely conventional by Wolf (Vol. 1, p.

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322). The reference does not appear to anneal in an oxidizing atmosphere, and thus discloses annealing in a non-oxidizing atmosphere, because the oxide formation and removal prior to epitaxial growth are not depicted. Alternatively, It would have been within the scope of one of ordinary skill in the art to omit oxidizing species form the annealing atmosphere because oxide formation is not disclosed as desired or depicted as occurring. Furthermore, Wolf discloses annealing in a non-oxidizing atmosphere (p. 305, 2<sup>nd</sup> paragraph). It would have been within the scope of one of ordinary skill in the art to combine the teachings of Wolf (p.305) with the process of the combination to enable the annealing step to be performed. Moreover, this will reduce oxide induced stacking fault (Wolf, p. 305). Heating of the substrate for some time period after the anneal step is in practice unavoidable when desiring to fully activate the implanted ions. Diffusion of the implanted impurities to expand the implanted region necessarily takes place during the anneal (Wolf, p. 307, third full paragraph). Wolf discloses epitaxial growth at temperatures equal to and above 1000°C to be conventional (p.136, fig. 14). It therefore would have been within the scope of one of ordinary skill in the art to perform the epitaxial growth step of Japan '833 at the temperatures equal to and above 1000°C shown to be suitable by Wolf. It also would have been within the scope of one of ordinary skill in the art to perform the epitaxial growth without cooling the wafer after annealing and diffusion of the implanted ions because cooling of the wafer is not disclosed as necessary by Japan '833 and because epitaxial growth temperature is higher than the annealing and diffusion temperatures. In view of the discussion of the prior art

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process in Japan '833 as well as the process of the invention it is clear that the silicon surface through which the implantation takes place is the same surface on which epitaxial growth takes place as opposed to a surface that is exposed by removal of an oxide layer formed during annealing (See p. 5, first full paragraph and p.6, 2<sup>nd</sup> paragraph, for example).

Neither reference discloses that the various steps are carried out all in the same reactor furnace. Bayraktaroglu discloses implanting ions in the substrate, activating them and epitaxial growth of a layer, all carried out in the same reactor chamber (Col. 3, lines 57-66). It would be within the scope of one of ordinary skill in the art to employ the method of Bayraktaroglu for its disclosed intended purpose to achieve the epitaxial layer formation step of the combination.

The examiner takes official notice that providing a cleaning gas such as H<sub>2</sub> or HCl to clean up the surface of the substrate was known at the time of the applicant's invention. It would have been within the scope of one of ordinary skill in the art to employ the known process for its known intended purpose to achieve the steps of the combination.

The choice of particular temperatures for the annealing/activation and epitaxial growth steps would have been a matter of routine optimization because temperatures for the steps are recognized as result effective variables. See MPEP 2144.05.

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## Response to Arguments

Applicant argues that the temperature recited in claim 1, lines 12-13 is not within the range that would be arrived at through routine optimization in view of the teachings of the reference. The result recited in line 13 appears to be due to absence of oxidizing species in the annealing atmosphere (Wolf 305 and Specification, p. 13, last paragraph).

Applicant argues that activation of implanted does not require or imply annealing. However, activation is an annealing process. + restore < rustal structure.

Applicant argues that there is no suggestion in any of the references and the Examiner has not even cited any part of a reference in support of an assertion that the modifications require to meet the claim requirements are suggested in the prior art. However, motivation has been provided in the office action mailed 11/18/02.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Michelle Estrada whose telephone number is (703) 308-0729. The examiner can normally be reached on Monday through Friday.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Olik Chaudhuri can be reached on 703-306-2794. The fax phone numbers for the organization where this application or proceeding is assigned are 703-308-7722 for regular communications and 703-308-7724 for After Final communications.

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Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is 703-308-0956.

George Fourson
Primary Examiner
Art Unit 2823

MEstrada

November 26, 2003